# **PCF8551**

# Universal 36 × 4 LCD segment driver Rev. 2 — 16 February 2015

**Product data sheet** 

#### 1. **General description**

PCF8551 is an ultra low-power LCD segment driver with 4 backplane- and 36 segment-driver outputs, with either an I<sup>2</sup>C- (PCF8551A) or an SPI-bus (PCF8551B) interface. It comprises an internal oscillator, bias generation, instruction decoding, and display controller.

For a selection of NXP LCD segment drivers, see Table 24 on page 45.

#### 2. **Features and benefits**

- Single chip LCD controller and driver
- Selectable backplane drive configuration: static, 2, 3, or 4 backplane multiplexing
- Selectable display bias configuration: static,  $\frac{1}{2}$ , or  $\frac{1}{3}$
- Internal LCD bias generation with buffers
- 36 segment drives:
  - Up to 18 7-segment numeric characters
  - Up to 9 14-segment alphanumeric characters
  - Any graphics of up to 144 segments/elements
- Auto-incrementing display data and instruction loading
- Versatile blinking modes
- Independent supplies of V<sub>LCD</sub> and V<sub>DD</sub>
- Power supply ranges:
  - ◆ 1.8 V to 5.5 V for V<sub>I CD</sub>
  - ◆ 1.8 V to 5.5 V for V<sub>DD</sub>
- Ultra low-power consumption
- 400 kHz I<sup>2</sup>C-bus interface (PCF8551A)
- 5 MHz SPI-bus interface (PCF8551B)
- Internally generated or externally supplied clock signal

# 3. Applications

- Metering equipment
- Consumer healthcare devices
- Battery operated devices
- Measuring equipment



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# 4. Ordering information

Table 1. Ordering information

| Type number | Package |   |          |  |  |  |
|-------------|---------|---|----------|--|--|--|
|             | Name    | Description   | Version  |  |  |  |
| PCF8551ATT  | TSSOP48 | plastic thin shrink small outline package;<br>48 leads; body width 6.1 mm | SOT362-1 |  |  |  |
| PCF8551BTT  | TSSOP48 | plastic thin shrink small outline package;<br>48 leads; body width 6.1 mm | SOT362-1 |  |  |  |

# 4.1 Ordering options

Table 2. Ordering options

| Product type number | Orderable part number | Sales item<br>(12NC) | Interface type       | Delivery form          | IC revision |
|---------------------|-----------------------|----------------------|----------------------|------------------------|-------------|
| PCF8551ATT/A        | PCF8551ATT/AJ         | 935304761118         | I <sup>2</sup> C-bus | tape and reel, 13 inch | 1           |
| PCF8551BTT/A        | PCF8551BTT/AJ         | 935305822118         | SPI-bus              | tape and reel, 13 inch | 1           |

# 5. Marking

Table 3. Marking codes

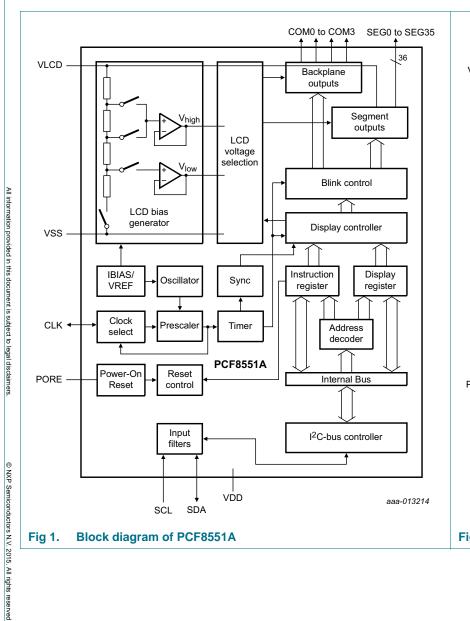
| Type number  | Marking code |
|--------------|--------------|
| PCF8551ATT/A | PCF8551A     |
| PCF8551BTT/A | PCF8551B     |

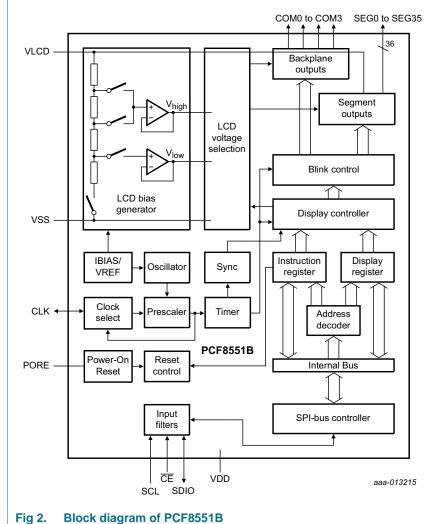
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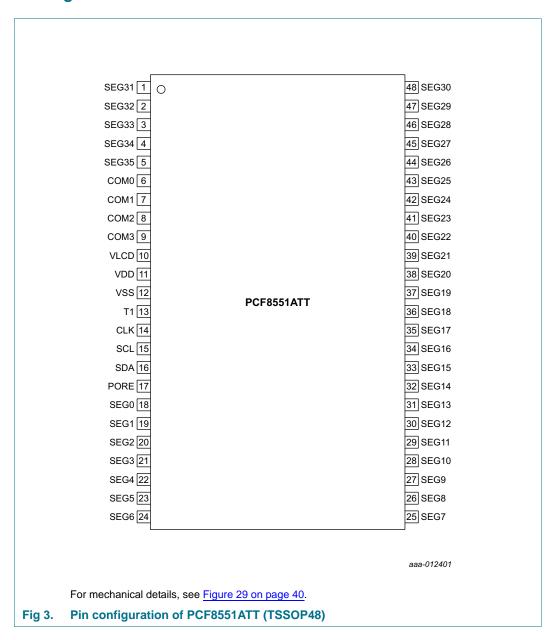




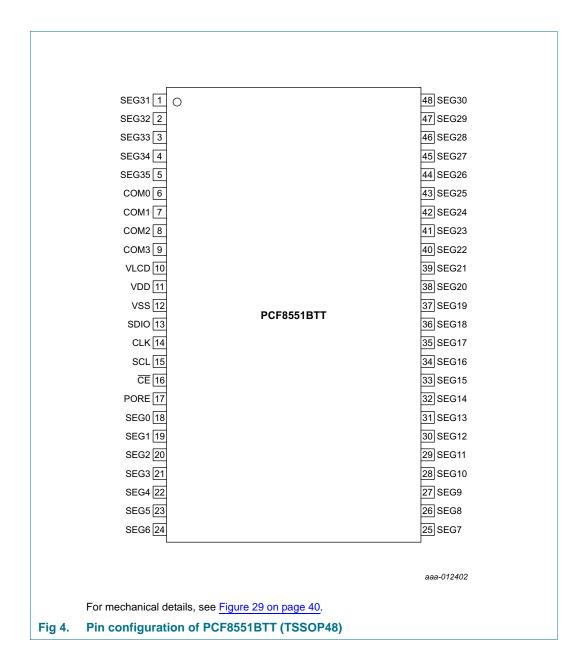
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# 7. Pinning information

# 7.1 Pinning



# Universal 36 × 4 LCD segment driver



# Universal 36 x 4 LCD segment driver

# 7.2 Pin description

Table 4. Pin description

Input or input/output pins must always be at a defined level (V<sub>SS</sub> or V<sub>DD</sub>) unless otherwise specified.

| Pin                 | Symbol                               |                         | Туре         | Description  |  |  |  |
|---------------------|--------------------------------------|-------------------------|--------------|--|--|--|--|
| 1 to 5,<br>18 to 48 | SEG0 to SEG3                         | 5                       | output       | LCD segment outputs  |  |  |  |
| 6 to 9              | COM0 to COM                          | 3                       | output       | LCD backplane outputs  |  |  |  |
| 10                  | VLCD                                 |                         | supply       | LCD supply voltage   |  |  |  |
| 11                  | VDD                                  |                         | supply       | supply voltage   |  |  |  |
| 12                  | VSS                                  |                         | supply       | ground supply  |  |  |  |
| 14                  | CLK                                  |                         | input/output | internal oscillator output, external oscillator input <sup>[1]</sup> • must be left open if unused                                     |  |  |  |
| 15                  | SCL                                  |                         | input        | serial clock input   |  |  |  |
| 17                  | PORE[2]                              | PORE[2]                 |              | Power-On Reset (POR) enable  connect to V <sub>DD</sub> for enabling POR  connect to V <sub>SS</sub> (or leave open) for disabling POR |  |  |  |
| Pin layo            | ut depending o                       | n product and b         | ous type     | common to 135 (cr. tours epeny to meaning to the   |  |  |  |
|                     | PCF8551ATT<br>(I <sup>2</sup> C-bus) | PCF8551BTT<br>(SPI-bus) |              |  |  |  |  |
| 13                  | T1                                   | -                       | -            | must be left open or connected to V <sub>SS</sub>  |  |  |  |
|                     | -                                    | SDIO input/output       |              | serial data input/output   |  |  |  |
| 16                  | SDA                                  | -                       | input/output | serial data line   |  |  |  |
|                     | - <del>CE</del> i                    |                         | input        | chip enable input, active LOW  |  |  |  |

<sup>[1]</sup> Can be configured by command, see <u>Table 6</u>.

<sup>[2]</sup> A series resistance between  $V_{DD}$  and the pin must not exceed 1 k $\Omega$  to ensure proper functionality, see Section 16.3.

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# 8. Functional description

# 8.1 Registers of the PCF8551

The registers of the PCF8551 are arranged in bytes with 8 bit, addressed by an address pointer. Table 5 depicts the layout.

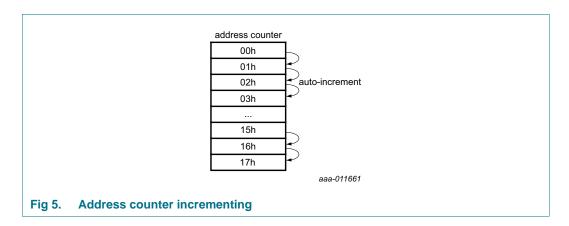
Table 5. Registers of the PCF8551

Bits labeled as 0 must always be written with logic 0; bits labeled as - are ignored by the device.

| Register name    | Address         | Bits  | Bits  |       |       |         |         |       |       |          |  |
|------------------|-----------------|-------|-------|-------|-------|---------|---------|-------|-------|----------|--|
|                  | AP[4:0]         | 7     | 6     | 5     | 4     | 3       | 2       | 1     | 0     |          |  |
| Command regis    | ters            | -     |       |       |       |         |         |       |       |          |  |
| Software_reset   | set 00h SR[7:0] |       |       |       |       |         |         |       |       | Table 9  |  |
| Device_ctrl      | 01h             | 0     | 0     | 0     | 0     | FF[1:0] |         | OSC   | COE   | Table 6  |  |
| Display_ctrl_1   | 02h             | 0     | 0     | 0     | BOOST | MUX[1:0 | )]      | В     | DE    | Table 7  |  |
| Display_ctrl_2   | 03h             | 0     | 0     | 0     | 0     | 0       | BL[1:0] | "     | INV   | Table 8  |  |
| Display data reg | gisters         |       |       |       |       |         |         |       |       |          |  |
| COM0             | 04h             | SEG7  | SEG6  | SEG5  | SEG4  | SEG3    | SEG2    | SEG1  | SEG0  | Table 10 |  |
|                  | 05h             | SEG15 | SEG14 | SEG13 | SEG12 | SEG11   | SEG10   | SEG9  | SEG8  |          |  |
|                  | 06h             | SEG23 | SEG22 | SEG21 | SEG20 | SEG19   | SEG18   | SEG17 | SEG16 |          |  |
|                  | 07h             | SEG31 | SEG30 | SEG29 | SEG28 | SEG27   | SEG26   | SEG25 | SEG24 |          |  |
|                  | 08h             | -     | -     | -     | -     | SEG35   | SEG34   | SEG33 | SEG32 |          |  |
| COM1             | 09h             | SEG7  | SEG6  | SEG5  | SEG4  | SEG3    | SEG2    | SEG1  | SEG0  |          |  |
|                  | 0Ah             | SEG15 | SEG14 | SEG13 | SEG12 | SEG11   | SEG10   | SEG9  | SEG8  |          |  |
|                  | 0Bh             | SEG23 | SEG22 | SEG21 | SEG20 | SEG19   | SEG18   | SEG17 | SEG16 |          |  |
|                  | 0Ch             | SEG31 | SEG30 | SEG29 | SEG28 | SEG27   | SEG26   | SEG25 | SEG24 |          |  |
|                  | 0Dh             | -     | -     | -     | -     | SEG35   | SEG34   | SEG33 | SEG32 |          |  |
| COM2             | 0Eh             | SEG7  | SEG6  | SEG5  | SEG4  | SEG3    | SEG2    | SEG1  | SEG0  |          |  |
|                  | 0Fh             | SEG15 | SEG14 | SEG13 | SEG12 | SEG11   | SEG10   | SEG9  | SEG8  |          |  |
|                  | 10h             | SEG23 | SEG22 | SEG21 | SEG20 | SEG19   | SEG18   | SEG17 | SEG16 |          |  |
|                  | 11h             | SEG31 | SEG30 | SEG29 | SEG28 | SEG27   | SEG26   | SEG25 | SEG24 |          |  |
|                  | 12h             | -     | -     | -     | -     | SEG35   | SEG34   | SEG33 | SEG32 |          |  |
| COM3             | 13h             | SEG7  | SEG6  | SEG5  | SEG4  | SEG3    | SEG2    | SEG1  | SEG0  |          |  |
|                  | 14h             | SEG15 | SEG14 | SEG13 | SEG12 | SEG11   | SEG10   | SEG9  | SEG8  |          |  |
|                  | 15h             | SEG23 | SEG22 | SEG21 | SEG20 | SEG19   | SEG18   | SEG17 | SEG16 |          |  |
|                  | 16h             | SEG31 | SEG30 | SEG29 | SEG28 | SEG27   | SEG26   | SEG25 | SEG24 |          |  |
|                  | 17h             | -     | -     | -     | -     | SEG35   | SEG34   | SEG33 | SEG32 |          |  |

For writing to the registers, send the address byte first, then write the data to the register (see Section 11.1.4 and Section 11.2.1). The address byte works as an address pointer. For the succeeding registers, the address pointer is automatically incremented by 1 (see Figure 5) and all following data are written into these register addresses. After register 18h, the auto-incrementing will stop and subsequent data are ignored.

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# 8.2 Command registers of the PCF8551

# 8.2.1 Command: Device\_ctrl

The Device\_ctrl command sets the device into a defined state. It should be executed before enabling the display (see bit DE in <u>Table 7</u>).

Table 6. Device ctrl - device control command register (address 01h) bit description

| Bit    | Symbol  | Value | Description                            |
|--------|---------|-------|--|
| 7 to 4 | -       | 0000  | default value                          |
| 3 to 2 | FF[1:0] |       | frame frequency selection              |
|        |         | 00    | f <sub>fr</sub> = 32 Hz                |
|        |         | 01[1] | f <sub>fr</sub> = 64 Hz                |
|        |         | 10    | f <sub>fr</sub> = 96 Hz                |
|        |         | 11    | f <sub>fr</sub> = 128 Hz               |
| 1      | 1 OSC   |       | internal oscillator control            |
|        |         | 0[1]  | enabled                                |
|        |         | 1     | disabled                               |
| 0      | COE     |       | clock output enable                    |
|        |         | 0[1]  | clock signal not available on pin CLK; |
|        |         |       | pin CLK is in 3-state                  |
|        |         | 1     | clock signal available on pin CLK      |

<sup>[1]</sup> Default value.

# 8.2.1.1 Internal oscillator and clock output

Bit OSC enables or disables the internal oscillator. When the internal oscillator is used, bit COE allows making the clock signal available on pin CLK. If this is not intended, pin CLK should be left open. The design ensures that the duty cycle of the clock output is 50:50 (% HIGH-level time: % LOW-level time).

In power-down mode (see Section 8.3.1)

- if pin CLK is configured as an output, there is no signal on CLK
- if pin CLK is configured as an input, the signal on CLK can be removed.

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In applications where an external clock has to be applied to the PCF8551, bit OSC must be set logic 1 and COE logic 0. In this case pin CLK becomes an input.

**Remark:** A clock signal must always be supplied to the device if the display is enabled (see bit DE in <u>Table 7 on page 9</u>). Removing the clock may freeze the LCD in a DC state, which is not suitable for the liquid crystal.

#### 8.2.2 Command: Display ctrl 1

The Display\_ctrl\_1 command allows configuring the basic display set-up.

Table 7. Display\_ctrl\_1 - display control command 1 register (address 02h) bit description

| Bit    | Symbol   | Value | Description  |
|--------|----------|-------|--|
| 7 to 5 | -        | 000   | default value  |
| 4      | BOOST    |       | large display mode support                                     |
|        |          | 0[1]  | standard power drive scheme                                    |
|        |          | 1     | enhanced power drive scheme for higher display loads           |
| 3 to 2 | MUX[1:0] |       | multiplex drive mode selection                                 |
|        |          | 00[1] | 1:4 multiplex drive mode; COM0 to COM3 (n <sub>MUX</sub> = 4)  |
|        |          | 01    | 1:3 multiplex drive mode; COM0 to COM2 (n <sub>MUX</sub> = 3)  |
|        |          | 10    | 1:2 multiplex drive mode; COM0 and COM1 (n <sub>MUX</sub> = 2) |
|        |          | 11    | static drive mode; COM0 (n <sub>MUX</sub> = 1)                 |
| 1      | B[2]     |       | bias mode selection  |
|        |          | 0[1]  | $\frac{1}{3}$ bias (a <sub>bias</sub> = 2)                     |
|        |          | 1     | $\frac{1}{2}$ bias (a <sub>bias</sub> = 1)                     |
| 0      | DE       |       | display enable <sup>[3]</sup>                                  |
|        |          | 0[1]  | display disabled; device is in power-down mode                 |
|        |          | 1     | display enabled; device is in power-on mode                    |

<sup>[1]</sup> Default value.

# 8.2.2.1 Enhanced power drive mode

By setting the BOOST bit to logic 1, the driving capability of the display signals is increased to cope with large displays with a higher effective capacitance. Setting this bit increases the current consumption on  $V_{LCD}$ .

## 8.2.2.2 Multiplex drive mode

MUX[1:0] sets the multiplex driving scheme and the associated backplane drive signals, which are active. For further details, see <u>Section 9.2 on page 16</u>.

<sup>[2]</sup> Not applicable for static drive mode.

<sup>[3]</sup> See Section 8.3.1.

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# 8.2.3 Command: Display\_ctrl\_2

Table 8. Display\_ctrl\_2 - display control command 2 register (address 03h) bit description

| Bit    | Symbol  | Value | Description                              |
|--------|---------|-------|--|
| 7 to 3 | -       | 00000 | default value                            |
| 2 to 1 | BL[1:0] |       | blink control                            |
|        |         | 00[1] | blinking off                             |
|        |         | 01    | blinking on, f <sub>blink</sub> = 0.5 Hz |
|        |         | 10    | blinking on, f <sub>blink</sub> = 1 Hz   |
|        |         | 11    | blinking on, f <sub>blink</sub> = 2 Hz   |
| 0      | INV     |       | inversion mode selection                 |
|        |         | O[1]  | line inversion (driving scheme A)        |
|        |         | 1     | frame inversion (driving scheme B)       |

<sup>[1]</sup> Default value.

#### 8.2.3.1 Blinking

The whole display blinks at frequencies selected by the blink control bits BL[1:0], see <u>Table 8</u>. The blink frequencies are derived from the clock frequency. During the blank-out phase of the blinking period, the display is turned off.

If an external clock with frequency  $f_{clk(ext)}$  is used, the blinking frequency is determined by Equation 1. For notation, see Section 9.2.

$$f_{blink(eff)} = \frac{2 \times n_{MUX} \times f_{fr} \times f_{blink}}{f_{clk(ext)}} \tag{1}$$

#### 8.2.3.2 Line inversion (driving scheme A) and frame inversion (driving scheme B)

The waveforms used to drive LCD inherently produce a DC voltage across the display cell. The PCF8551 compensates for the DC voltage by inverting the waveforms on alternate frames or alternate lines. The choice of compensation method is determined with the INV bit.

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# 8.3 Starting and resetting the PCF8551

If the internal Power-On Reset (POR) is enabled by connecting pin PORE to  $V_{DD}$ , the chip resets automatically when  $V_{DD}$  rises above the minimum supply voltage. No further action is required.

If the internal POR is disabled by connecting pin PORE to  $V_{SS}$ , the chip must be reset by a software reset (see Section 8.3.3).

Following a reset, the register 00h has to be rewritten with 0h by the next command byte or the address pointer AP[4:0] has to be set to the required address after a new START procedure.

#### 8.3.1 Power-down mode

After a reset, the PCF8551 remains in power-down mode. In power-down mode the oscillator is switched off and there is no output on pin CLK. The register settings remain unchanged and the bus remains active. To enable the PCF8551, bit DE (command Display\_ctrl\_1, see Table 7 on page 9) must be set to logic 1.

# 8.3.2 Power-On Reset (POR)

If pin PORE is connected to V<sub>DD</sub>, the PCF8551 comprises an internal POR, which puts the device into the following starting conditions:

- All backplane and segment outputs are set to V<sub>SS</sub>
- The selected drive mode is: 1:4 multiplex with ½ bias
- · Blinking is switched off
- The address pointer is cleared (set to logic 0)
- The display and the internal oscillator are disabled
- The display registers are set to logic 0

**Remark:** The internal POR can be disabled by connecting pin PORE to  $V_{SS}$ . In this case, the internal registers are not defined and require a software reset, see Section 8.3.3.

Remark: For power-on with a slowly starting power supply, see Section 16.1 on page 39.

#### 8.3.3 Command: Software\_reset

The internal registers including the display registers and the address pointer (set to logic 0) of the device are reset by the Software\_reset command.

Table 9. Software\_reset - software reset command register (address 00h) bit description

| Bit    | Symbol     | Value       | Description    |
|--------|------------|-------------|----------------|
| 7 to 0 | SR[7:0][1] |             | software reset |
|        |            | 00000000[2] | no reset       |
|        |            | 00101100    | software reset |

- [1] Software\_reset only generates a reset pulse, therefore this register always reads back as 00h.
- [2] Default value.

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# 8.4 Display data register mapping

Table 10. Register to segment and backplane mapping

| Backplanes[1]   | Segments     |       |            |        |            |                |            |                |         |                |  |
|-----------------|--------------|-------|------------|--------|------------|----------------|------------|----------------|---------|----------------|--|
|                 | SEG0 to SEG7 |       | SEG8 to    | SEG15  | SEG16 to   | SEG16 to SEG23 |            | SEG24 to SEG31 |         | SEG32 to SEG35 |  |
|                 | LSB          | MSB   | LSB        | MSB    | LSB        | MSB            | LSB        | MSB            | LSB     | MSB            |  |
| 1:4 multiplex d | rive mode    | е     |            |        |            |                |            |                |         |                |  |
| COM0            | content o    | f 04h | content of | of 05h | content of | f 06h          | content of | of 07h         | content | of 08h         |  |
| COM1            | content o    | f 09h | content of | of 0Ah | content of | f 0Bh          | content of | of 0Ch         | content | of 0Dh         |  |
| COM2            | content o    | f 0Eh | content of | of 0Fh | content of | f 10h          | content of | of 11h         | content | of 12h         |  |
| COM3            | content o    | f 13h | content of | of 14h | content of | f 15h          | content of | of 16h         | content | of 17h         |  |
| 1:3 multiplex d | rive mode    | е     | ,          |        |            |                |            |                |         |                |  |
| COM0            | content o    | f 04h | content of | of 05h | content of | f 06h          | content of | of 07h         | content | of 08h         |  |
| COM1            | content o    | f 09h | content of | of 0Ah | content of | f 0Bh          | content of | of 0Ch         | content | of 0Dh         |  |
| COM2            | content o    | f 0Eh | content of | of 0Fh | content of | f 10h          | content of | of 11h         | content | of 12h         |  |
| 1:2 multiplex d | rive mode    | е     | ,          |        |            |                |            |                |         |                |  |
| COM0            | content o    | f 04h | content of | of 05h | content of | 606h           | content of | of 07h         | content | of 08h         |  |
| COM1            | content o    | f 09h | content of | of 0Ah | content of | f 0Bh          | content of | of 0Ch         | content | of 0Dh         |  |
| static drive mo | de           |       |            |        | -          |                | '          |                | -       |                |  |
| COM0            | content o    | f 04h | content    | of 05h | content of | 06h            | content of | of 07h         | content | of 08h         |  |

#### [1] See also Section 9.3.1 on page 24

The example in <u>Table 10</u> and <u>Figure 6</u> illustrates the segment and backplane mapping of the display in relation to the display RAM.

For example, in 1:4 multiplex drive mode, the backplanes are served by signals COM0 to COM3 and the segments are driven by signals SEG0 to SEG35. Contents of addresses 04h to 08h are allocated to the first row (COM0) starting with the LSB driving the leftmost element and moving forward to the right with increasing bit position. If a bit is logic 0, the element is off, if it is logic 1 the element is turned on. All register content is LSB to MSB left to right. Addresses 09h to 0Dh serve COM1 signals, addresses 0Eh to 12h serve COM2 signals, and addresses 13h to 17h serve COM3 signals.

For displays with fewer segments/elements, the unused bits are ignored.

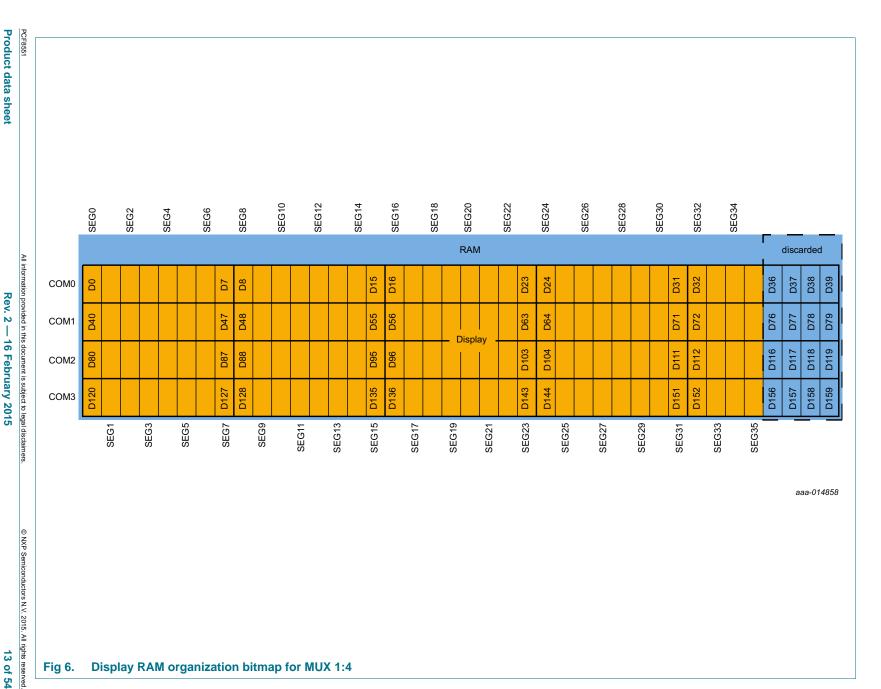


Fig 6.

Display RAM organization bitmap for MUX 1:4

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# 9. Possible display configurations

The possible display configurations of the PCF8551 depend on the number of active backplane outputs required. A selection of display configurations is shown in <u>Table 11</u>. All of these configurations can be implemented in the typical systems shown in <u>Figure 8</u> or <u>Figure 9</u>.

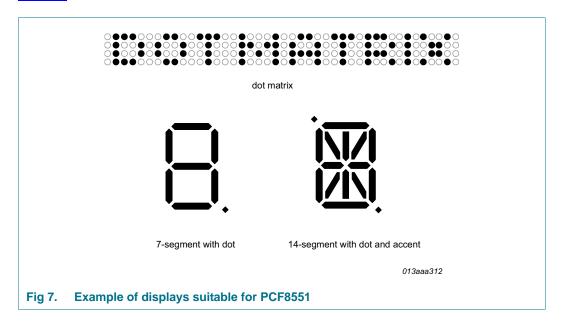


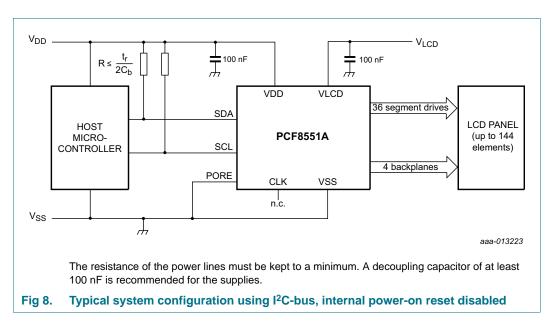
Table 11. Selection of possible display configurations

| Number of  |       |                          |                   |                       |  |  |  |
|------------|-------|--------------------------|-------------------|-----------------------|--|--|--|
| Backplanes | Icons | Digits/Characte          | Digits/Characters |                       |  |  |  |
|            |       | 7-segment <sup>[1]</sup> | 14-segment[2]     | segments/<br>elements |  |  |  |
| 4          | 144   | 18                       | 9                 | 144 dots (4 × 36)     |  |  |  |
| 3          | 108   | 13                       | 6                 | 108 dots (3 × 36)     |  |  |  |
| 2          | 72    | 9                        | 4                 | 72 dots (2 × 36)      |  |  |  |
| 1          | 36    | 4                        | 2                 | 36 dots (1 × 36)      |  |  |  |

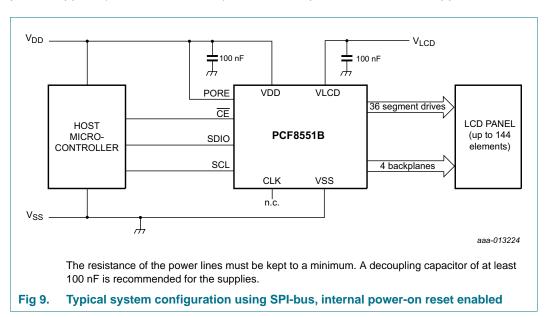
<sup>[1] 7</sup> segment display has 8 segments/elements including the decimal point.

<sup>[2] 14</sup> segment display has 16 segments/elements including decimal point and accent dot.

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The host microcontroller manages the 2-line  $I^2C$ -bus communication channel with the PCF8551A. The internal oscillator is used and the internal POR is disabled in the example. The appropriate biasing voltages for the multiplexed LCD waveforms are generated internally. The only other connections required to complete the system are the power supplies ( $V_{DD}$ ,  $V_{SS}$ , and  $V_{LCD}$ ) and the LCD panel chosen for the application.



The host microcontroller manages the 3-line SPI-bus communication channel with the PCF8551B. The internal oscillator is enabled. The appropriate biasing voltages for the multiplexed LCD waveforms are generated internally. The only other connections required to complete the system are the power supplies ( $V_{DD}$ ,  $V_{SS}$ , and  $V_{LCD}$ ) and the LCD panel chosen for the application.

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# 9.1 LCD bias generator

Fractional LCD biasing voltages are obtained from an internal voltage divider of three impedances connected between  $V_{LCD}$  and  $V_{SS}$ . These intermediate levels are tapped off at positions of  $\frac{1}{3}$  and  $\frac{2}{3}$ , or  $\frac{1}{2}$ , depending on the bias mode chosen. To keep current consumption to a minimum, on-chip low-power buffers provide these levels to the display.

# 9.2 LCD voltage selector

The LCD voltage selector coordinates the multiplexing of the LCD in accordance with the selected LCD drive configuration. The operation of the voltage selector is controlled by the Display\_ctrl\_1 command (see  $\underline{\text{Table 7}}$ ). The biasing configurations that apply to the preferred modes of operation, together with the biasing characteristics as functions of  $V_{\text{LCD}}$  and the resulting discrimination ratios (D) are given in  $\underline{\text{Table 12}}$ .

Table 12. Biasing characteristics

| LCD drive     |            |        | LCD bias      | V <sub>off(RMS)</sub> | $V_{on(RMS)}$    | $D = \frac{V_{on(RMS)}}{V_{on(RMS)}}$    |
|---------------|------------|--------|---------------|-----------------------|------------------|--|
| mode          | Backplanes | Levels | configuration | V <sub>LCD</sub>      | V <sub>LCD</sub> | $D = \frac{\delta h(RMS)}{V_{off(RMS)}}$ |
| static        | 1          | 2      | static        | 0                     | 1                | $\infty$                                 |
| 1:2 multiplex | 2          | 3      | 1/2           | 0.354                 | 0.791            | 2.236                                    |
| 1:2 multiplex | 2          | 4      | 1/3           | 0.333                 | 0.745            | 2.236                                    |
| 1:3 multiplex | 3          | 4      | 1/3           | 0.333                 | 0.638            | 1.915                                    |
| 1:4 multiplex | 4          | 4      | 1/3           | 0.333                 | 0.577            | 1.732                                    |

A practical value for  $V_{LCD}$  is determined by equating  $V_{off(RMS)}$  with a defined LCD threshold voltage ( $V_{th(off)}$ ), typically when the LCD exhibits approximately 10 % contrast. In the static drive mode, a suitable choice is  $V_{LCD} > 3V_{th(off)}$ .

Multiplex drive modes of 1:3 and 1:4 with  $\frac{1}{2}$  bias are possible but the discrimination and hence the contrast ratios are smaller.

Bias is calculated with Equation 2

$$\frac{1}{1+a_{bias}} \tag{2}$$

The values for abias are:

$$a_{bias} = 1$$
 for  $\frac{1}{2}$  bias

$$a_{bias} = 2 \text{ for } \frac{1}{3} \text{ bias}$$

The RMS on-state voltage (Von(RMS)) for the LCD is calculated with Equation 3:

$$V_{on(RMS)} = V_{LCD} \sqrt{\frac{a_{bias}^2 + 2a_{bias} + n_{MUX}}{n_{MUX} \times (1 + a_{bias})^2}}$$
(3)

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where the values for n are

n<sub>MUX</sub> = 1 for static drive mode

 $n_{MLIX} = 2$  for 1:2 multiplex drive mode

n<sub>MUX</sub> = 3 for 1:3 multiplex drive mode

 $n_{MLIX} = 4$  for 1:4 multiplex drive mode

The RMS off-state voltage (V<sub>off(RMS)</sub>) for the LCD is calculated with Equation 4:

$$V_{off(RMS)} = V_{LCD} \sqrt{\frac{a_{bias}^2 - 2a_{bias} + n_{MUX}}{n_{MUX} \times (1 + a_{bias})^2}}$$
(4)

Discrimination is a term which is defined as the ratio of the on and off RMS voltages  $(V_{on(RMS)})$  to  $V_{off(RMS)}$  across a segment. It can be thought of as a measurement of contrast. Discrimination is determined from Equation 5:

$$D = \frac{V_{on(RMS)}}{V_{off(RMS)}} = \sqrt{\frac{a_{bias}^2 + 2a_{bias} + n_{MUX}}{a_{bias}^2 - 2a_{bias} + n_{MUX}}}$$
(5)

Using Equation 5, the discrimination for an LCD drive mode of 1:3 multiplex with  $\frac{1}{2}$  bias is  $\sqrt{3} = 1.732$  and the discrimination for an LCD drive mode of 1:4 multiplex with  $\frac{1}{2}$  bias is  $\frac{\sqrt{21}}{3} = 1.528$ .

The advantage of these LCD drive modes is a reduction of the LCD full scale voltage  $V_{LCD}$  as follows:

- 1:3 multiplex (½ bias):  $V_{LCD} = \sqrt{6} \times V_{off(RMS)} = 2.449 V_{off(RMS)}$
- 1:4 multiplex ( $\frac{1}{2}$  bias):  $V_{LCD} = \left\lceil \frac{(4 \times \sqrt{3})}{3} \right\rceil = 2.309 V_{off(RMS)}$

These compare with  $V_{LCD} = 3V_{off(RMS)}$  when  $\frac{1}{3}$  bias is used.

V<sub>LCD</sub> is sometimes referred as the LCD operating voltage.

#### 9.2.1 Electro-optical performance

Suitable values for  $V_{on(RMS)}$  and  $V_{off(RMS)}$  are dependent on the LCD liquid used. The RMS voltage, at which a pixel is switched on or off, determine the transmissibility of the pixel.

For any given liquid, there are two threshold values defined. One point is at 10 % relative transmission (at  $V_{th(off)}$ ) and the other at 90 % relative transmission (at  $V_{th(on)}$ ), see Figure 10. For a good contrast performance, the following rules should be followed:

$$V_{on(RMS)} \ge V_{th(on)} \tag{6}$$

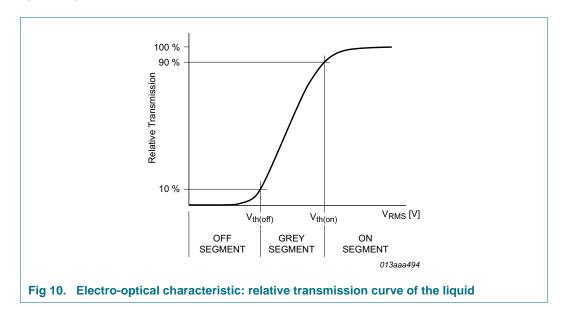
$$V_{off(RMS)} \le V_{th(off)} \tag{7}$$

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 $V_{on(RMS)}$  (see <u>Equation 3</u>) and  $V_{off(RMS)}$  (see <u>Equation 5</u>) are properties of the display driver and are affected by the selection of  $a_{bias}$ ,  $n_{MUX}$ , and the  $V_{LCD}$  voltage.

 $V_{th(off)}$  and  $V_{th(on)}$  are properties of the LCD liquid and can be provided by the module manufacturer.  $V_{th(off)}$  is sometimes named  $V_{th}$ .  $V_{th(on)}$  is sometimes named saturation voltage  $V_{sat}$ .

It is important to match the module properties to those of the driver in order to achieve optimum performance.

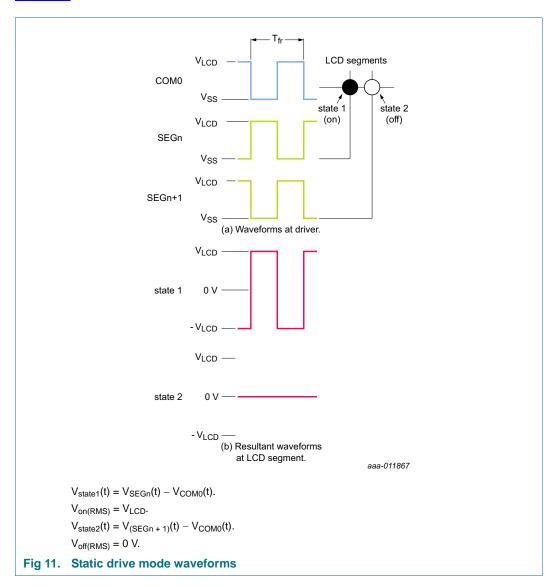


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# 9.2.2 LCD drive mode waveforms

#### 9.2.2.1 Static drive mode

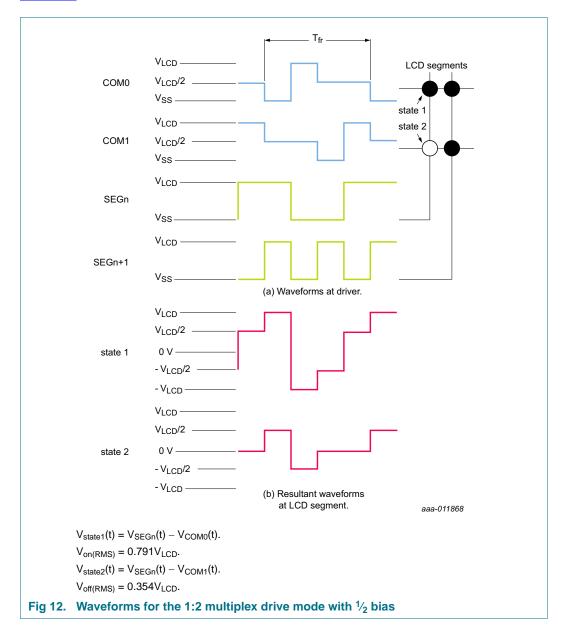
The static LCD drive mode is used when a single backplane is provided in the LCD. The backplane (COMn) and segment (SEGn) drive waveforms for this mode are shown in Figure 11.



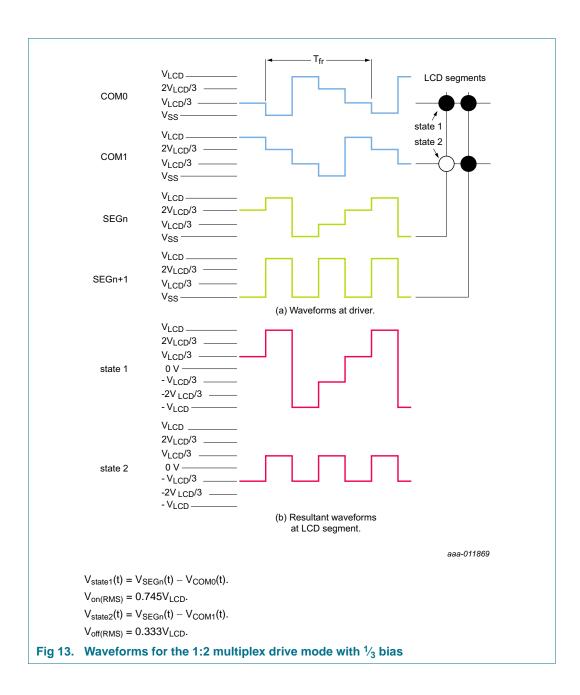
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# 9.2.2.2 1:2 Multiplex drive mode

When two backplanes are provided in the LCD, the 1:2 multiplex mode applies. The PCF8551 allows the use of  $\frac{1}{2}$  bias or  $\frac{1}{3}$  bias in this mode as shown in Figure 12 and Figure 13.



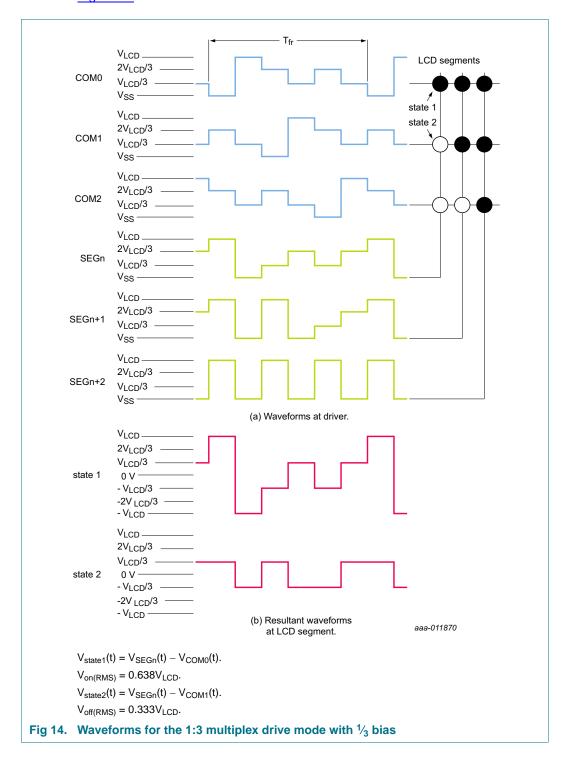
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# 9.2.2.3 1:3 Multiplex drive mode

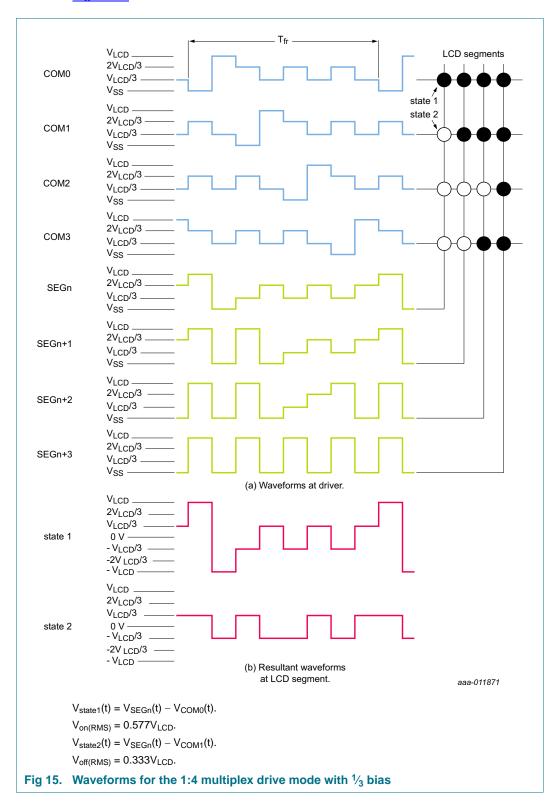
When three backplanes are provided in the LCD, the 1:3 multiplex drive mode applies, as shown in Figure 14.



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# 9.2.2.4 1:4 Multiplex drive mode

When four backplanes are provided in the LCD, the 1:4 multiplex drive mode applies as shown in Figure 15.



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# 9.3 Backplane and segment outputs

# 9.3.1 Backplane outputs

The LCD drive section includes four backplane outputs COM0 to COM3, which must be directly connected to the LCD. The backplane output signals are generated in accordance with the selected LCD drive mode. If less than four backplane outputs are required, the unused outputs can be left open-circuit.

- In 1:3 multiplex drive mode, COM3 carries the same signal as COM1, therefore these two outputs can be tied together to give enhanced drive capabilities
- In 1:2 multiplex drive mode, COM0 and COM2, respectively, COM1 and COM3 all carry the same signals and may also be paired to increase the drive capabilities
- In static drive mode, the same signal is carried by all four backplane outputs and they can be connected in parallel for very high drive requirements

## 9.3.2 Segment outputs

The LCD drive section includes 36 segment outputs SEG0 to SEG35, which must be directly connected to the LCD. The segment output signals are generated in accordance with the multiplexed backplane signals and with data residing in the display registers. When less than 36 segment outputs are required, the unused segment outputs must be left open-circuit.

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# 10. Power Sequencing

## 10.1 Power-on

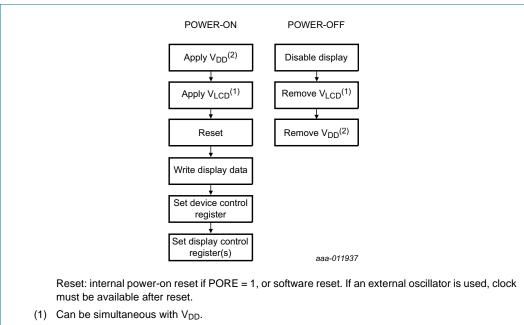
To avoid unwanted artifacts on the display,  $V_{LCD}$  must never be asserted before  $V_{DD}$ , it is permitted to assert  $V_{DD}$  and  $V_{LCD}$  at the same time.

# 10.2 Power-off

Before turning the power to the device off, the display must be disabled by setting bit DE to logic 0. To avoid unwanted artifacts on the display,  $V_{LCD}$  must never be connected, while  $V_{DD}$  is switched off. It is permitted to switch off  $V_{DD}$  and  $V_{LCD}$  simultaneously.

# 10.3 Power sequences

Figure 16 depicts the recommended power-up and power-off sequence.



(2) Can be simultaneous with V<sub>LCD</sub>.

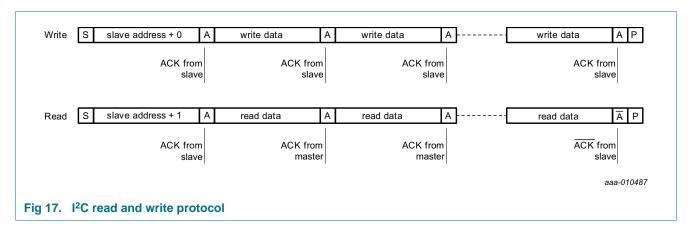
Fig 16. Recommended power-up and power-off sequence

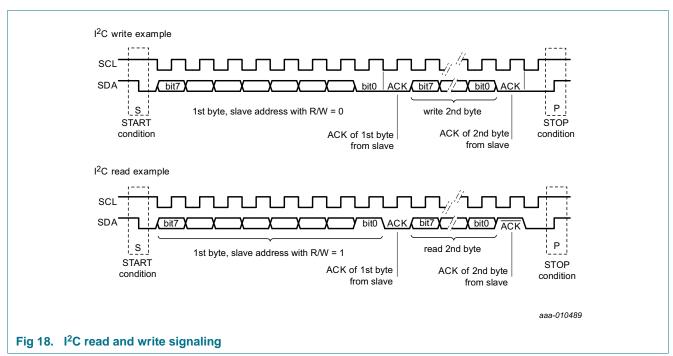
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# 11. Bus interfaces

#### 11.1 I<sup>2</sup>C-bus interface of the PCF8551A

The I<sup>2</sup>C-bus is for bidirectional, two-line communication between different ICs. The two lines are a Serial DAta line (SDA) and a Serial CLock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor. Data transfer may be initiated only when the bus is not busy. Both data and clock lines remain HIGH when the bus is not busy. The PCF8551A acts as a slave receiver when being written to and as a slave transmitter when being read from.





#### 11.1.1 Bit transfer

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the HIGH period of the clock pulse, as changes in the data line at this time are interpreted as STOP or START conditions.

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#### 11.1.2 START and STOP conditions

A HIGH-to-LOW transition of the data line while the clock is HIGH is defined as the START condition - S.

A LOW-to-HIGH transition of the data line while the clock is HIGH is defined as the STOP condition - P (see Figure 18).

#### 11.1.3 Acknowledge

Each byte of 8 bits is followed by an acknowledge cycle. An acknowledge is defined as logic 0. A not-acknowledge is defined as logic 1.

When written to, the slave will generate an acknowledge after the reception of each byte. After the acknowledge, another byte may be transmitted. It is also possible to send a STOP or START condition.

When read from, the master receiver must generate an acknowledge after the reception of each byte. When the master receiver no longer requires bytes to be transmitted, it must generate a not-acknowledge. After the not-acknowledge, either a STOP or START condition must be sent.

**Remark:** The PCF8551A omits the not-acknowledge. After the last byte read, the end of transmission is indicated by a STOP or START condition from the master.

A detailed description of the I<sup>2</sup>C-bus specification is given in Ref. 12 "UM10204".

# 11.1.4 I<sup>2</sup>C interface protocol

The PCF8551A uses the I<sup>2</sup>C interface for data transfer. Interpretation of the data is determined by the interface protocol.

# 11.1.4.1 Write protocol

After the I<sup>2</sup>C slave address is transmitted, the PCF8551A requires that the register address pointer is defined. It can take the value 00h to 17h. Values outside of that range will result in the transfer being ignored, however the slave will still respond with acknowledge pulses.

After the register address has been transmitted, write data is transmitted. The minimum number of data write bytes is 0 and the maximum number is unlimited. After each write, the address pointer increments by one. After address 17h, the address pointer stops incrementing at 18h.

- I<sup>2</sup>C START condition
- I<sup>2</sup>C slave address + write
- start register pointer
- write data
- write data
- •
- write data
- I<sup>2</sup>C STOP condition; an I<sup>2</sup>C RE-START condition is also possible.

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# 11.1.4.2 Read protocol

When reading the PCF8551A, reading starts at the current position of the address pointer. The address pointer for read data should first be defined by a write sequence.

- I<sup>2</sup>C START condition
- I2C slave address + write
- start address pointer
- I<sup>2</sup>C STOP condition; an I<sup>2</sup>C RE-START condition is also possible.

After setting the address pointer, a read can be executed. After the I<sup>2</sup>C slave address is transmitted, the PCF8551A will immediately output read data. After each read, the address pointer increments by one. After address 17h, the address pointer stops incrementing at 18h.

- I2C START condition
- I<sup>2</sup>C slave address + read
- read data (master sends acknowledge bit)
- read data (master sends acknowledge bit)
- •

#### 11.1.4.3 I<sup>2</sup>C-bus slave address

Device selection depends on the I<sup>2</sup>C-bus slave address (see Table 13).

Table 13. I<sup>2</sup>C slave address byte

| Slave address |          |   |   |   |   |   |   |          |
|---------------|----------|---|---|---|---|---|---|----------|
| Bit           | 7<br>MSB | 6 | 5 | 4 | 3 | 2 | 1 | 0<br>LSB |
|               | 0        | 1 | 1 | 1 | 0 | 0 | 0 | R/W      |

The least significant bit of the slave address byte is bit R/W (see Table 14).

Table 14. R/W-bit description

| R/W | Description |
|-----|-------------|
| 0   | write data  |
| 1   | read data   |

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#### 11.2 SPI-bus interface of the PCF8551B

Data transfer to the device is made via a 3-line SPI-bus (see <u>Table 15</u>). There is no dedicated output data line. The SPI-bus is initialized whenever the chip enable line pin <u>CE</u> is pulled down.

Table 15. Serial interface

| •    | Function                         | Description   |  |  |  |  |
|------|----------------------------------|---|--|--|--|--|
| CE   | chip enable input[1]; active LOW | when HIGH, the interface is reset   |  |  |  |  |
| SCL  | serial clock input               | input may be higher than V <sub>DD</sub>  |  |  |  |  |
| SDIO | serial data input/output         | input data are sampled on the rising edge of SCL, output data are valid after the falling edge of SCL |  |  |  |  |

<sup>[1]</sup> The chip enable must not be wired permanently LOW.

#### 11.2.1 Data transmission

The chip enable signal is used to identify the transmitted data. Each data transfer is a byte with the Most Significant Bit (MSB) sent first.

The transmission is controlled by the active LOW chip enable signal  $\overline{CE}$ . The first byte transmitted is the register address comprising of the address pointer and the R/W bit.

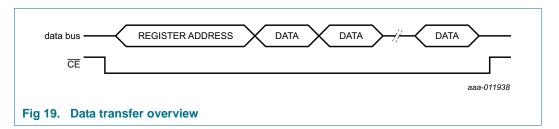


Table 16. Address byte definition

| Bit    | Symbol  | Value      | Description                              |
|--------|---------|------------|--|
| 7 R/W  |         |            | data read or write selection             |
|        |         | 0          | write data                               |
|        |         | 1          | read data                                |
| 6 to 5 | -       | 00         | default value                            |
| 4 to 0 | AP[4:0] |            | pointer to register start address        |
|        |         | 00h to 17h | valid range; other addresses are ignored |

After the register address byte, the register contents follows with the address pointer being auto-incremented after every eighth bit sent (see <u>Section 8.1 on page 7</u>).

#### 11.2.1.1 Write protocol

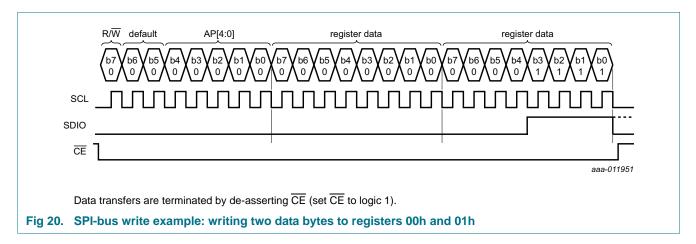
After the  $\overline{\text{CE}}$  is set LOW, the PCF8551B requires that R/W and the register address pointer is defined. It can take the value 00h to 17h. Values outside of that range result in the transfer being ignored.

After the register address has been transmitted, write data is transmitted. The minimum number of data write bytes is 0 and the maximum number is unlimited. After each write, the address pointer increments by one. After address 17h, the address pointer stops incrementing at 18h.

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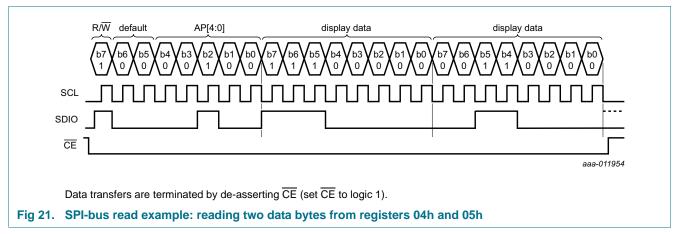
- CE set LOW
- $R/\overline{W} = 0$  and register address
- write data
- write data
- •
- write data
- CE set HIGH



# 11.2.1.2 Read protocol

When reading the PCF8551B, reading starts at the defined position of the address pointer. After setting the address pointer, the read can be executed. After each read, the address pointer increments by one. After address 17h, the address pointer stops incrementing at 18h.

- Œ set LOW
- $R/\overline{W} = 1$  and register address
- read data
- · read data
- :
- CE set HIGH



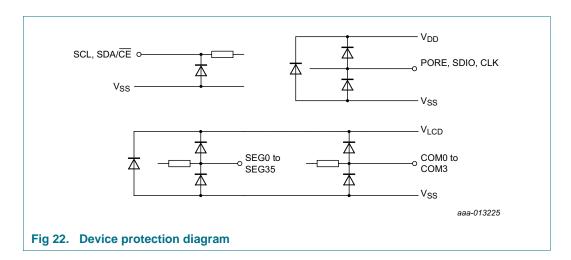
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## 11.3 EMC detection

The PCF8551 is ruggedized against EMC susceptibility; however it is not possible to cover all cases. To detect if a severe EMC event has occurred, it is possible to check the responsiveness of the device by reading its registers.

# 12. Internal circuitry



# 13. Safety notes

# CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

#### **CAUTION**



Static voltages across the liquid crystal display can build up when the LCD supply voltage  $(V_{LCD})$  is on while the IC supply voltage  $(V_{DD})$  is off, or vice versa. This may cause unwanted display artifacts. To avoid such artifacts,  $V_{LCD}$  and  $V_{DD}$  must be applied or removed together.

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# 14. Limiting values

Table 17. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol               | Parameter               | Conditions           |     | Min  | Max   | Unit |
|----------------------|-------------------------|----------------------|-----|------|-------|------|
| $V_{DD}$             | supply voltage          |                      |     | -0.5 | +6.5  | V    |
| $V_{LCD}$            | LCD supply voltage      |                      |     | -0.5 | +6.5  | V    |
| VI                   | input voltage           |                      |     | -0.5 | +6.5  | V    |
| Vo                   | output voltage          |                      |     | -0.5 | +6.5  | V    |
| I <sub>I</sub>       | input current           |                      |     | -10  | +10   | mA   |
| Io                   | output current          |                      |     | -10  | +10   | mA   |
| I <sub>DD</sub>      | supply current          |                      |     | -50  | +50   | mA   |
| I <sub>DD(LCD)</sub> | LCD supply current      |                      |     | -50  | +50   | mA   |
| I <sub>SS</sub>      | ground supply current   |                      |     | -50  | +50   | mA   |
| P <sub>tot</sub>     | total power dissipation |                      |     | -    | 100   | mW   |
| Po                   | output power            |                      |     | -    | 100   | mW   |
| V <sub>ESD</sub>     | electrostatic discharge | НВМ                  | [1] |      | ,     | ,    |
|                      | voltage                 | on pins SCL, SDA, CE |     | -    | ±2000 | V    |
|                      |                         | on all other pins    |     | -    | ±5000 | V    |
|                      |                         | CDM                  | [2] | -    | ±500  | V    |
| I <sub>lu</sub>      | latch-up current        |                      | [3] | -    | 200   | mA   |
| T <sub>stg</sub>     | storage temperature     |                      | [4] | -55  | +150  | °C   |
| T <sub>amb</sub>     | ambient temperature     | operating device     |     | -40  | +85   | °C   |

<sup>[1]</sup> Pass level; Human Body Model (HBM), according to Ref. 7 "JESD22-A114".

<sup>[2]</sup> Pass level; Charged-Device Model (CDM), according to Ref. 8 "JESD22-C101".

<sup>[3]</sup> Pass level; latch-up testing according to Ref. 9 "JESD78" at maximum ambient temperature (T<sub>amb(max)</sub>).

<sup>[4]</sup> According to the store and transport requirements (see Ref. 13 "UM10569") the devices have to be stored at a temperature of +8 °C to +45 °C and a humidity of 25 % to 75 %.

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# 15. Characteristics

Table 18. Electrical characteristics

 $V_{DD}$  = 1.8 V to 5.5 V;  $V_{SS}$  = 0 V;  $V_{LCD}$  = 1.8 V to 5.5 V;  $T_{amb}$  = -40 °C to +85 °C; unless otherwise specified.

| Symbol                 | Parameter                          | Conditions   | Min                    | Тур | Max                | Unit |  |  |
|------------------------|------------------------------------|--|------------------------|-----|--------------------|------|--|--|
| Supplies               |                                    |  |                        |     | <u> </u>           |      |  |  |
| $V_{DD}$               | supply voltage                     |  | 1.8                    | -   | 5.5                | V    |  |  |
| $V_{LCD}$              | LCD supply voltage                 |  | 1.8                    | -   | 5.5                | V    |  |  |
| I <sub>DD</sub>        | supply current                     | f <sub>fr</sub> = 64 Hz; no bus activity   |                        |     | '                  |      |  |  |
|                        |                                    | $V_{DD} = 3.3 \text{ V}; T_{amb} = 25 ^{\circ}\text{C}$  | -                      | 0.6 | -                  | μΑ   |  |  |
|                        |                                    | V <sub>DD</sub> = 5.5 V; T <sub>amb</sub> = 85 °C  | -                      | 1.2 | 2.7                | μΑ   |  |  |
| I <sub>DD(LCD)</sub>   | LCD supply current                 | $f_{fr} = 64 \text{ Hz}$ ; no bus activity [1]   |                        |     |                    |      |  |  |
|                        |                                    | $V_{LCD} = 5.5 \text{ V};$ $T_{amb} = 85 \text{ °C};$ $BOOST = 0;$ no display load             | -                      | 3.2 | 4.5                | μА   |  |  |
|                        |                                    | V <sub>LCD</sub> = 3.3 V;<br>T <sub>amb</sub> = 25 °C  |                        |     |                    |      |  |  |
|                        |                                    | BOOST = 0;<br>no display load  | -                      | 2.5 | -                  | μΑ   |  |  |
|                        |                                    | BOOST = 0;<br>display enabled;<br>display load $C_L = 1.4 \text{ nF}$                          | -                      | 4.5 | -                  | μΑ   |  |  |
|                        |                                    | BOOST = 1;<br>display enabled;<br>display load C <sub>L</sub> = 1.4 nF                         | -                      | 5.5 | -                  | μΑ   |  |  |
| V <sub>IL</sub>        | LOW-level input voltage            |  | V <sub>SS</sub>        | -   | 0.3V <sub>DD</sub> | V    |  |  |
| V <sub>IH</sub>        | HIGH-level input voltage           |  | [2] 0.7V <sub>DD</sub> | -   | $V_{DD}$           | V    |  |  |
| I <sub>OL</sub>        | LOW-level output current           | output sink current;<br>V <sub>OL</sub> = 0.4 V; V <sub>DD</sub> = 5 V                         |                        |     |                    | ,    |  |  |
|                        |                                    | on pin CLK   | 2                      | -   | -                  | mA   |  |  |
|                        |                                    | on pin SDIO  | 2                      | -   | -                  | mA   |  |  |
|                        |                                    | on pin SDA   | 3                      | -   | -                  | mA   |  |  |
| I <sub>OH</sub>        | HIGH-level output current          | output source current;<br>on pins SDIO, CLK;<br>V <sub>OH</sub> = 4.6 V; V <sub>DD</sub> = 5 V | 2                      | -   | -                  | mA   |  |  |
| IL                     | leakage current                    | any input pin except for RST   | -                      | 0   | -                  | nA   |  |  |
|                        |                                    | after ESD event  | -500                   | -   | +500               | nA   |  |  |
| R <sub>pu(RST_n)</sub> | pull-up resistance on pin<br>RST_N |  | -                      | 100 | -                  | kΩ   |  |  |
| LCD outpu              | its (pins SEG0 to SEG17 an         | d COM0 to COM3)  |                        |     | ·                  |      |  |  |
| $\Delta V_{o}$         | output voltage variation           | V <sub>LCD</sub> = 5 V   | -100                   | -   | +100               | mV   |  |  |
| Ro                     | output resistance                  | V <sub>LCD</sub> = 5 V   | [3]                    | 1.5 | 3                  | kΩ   |  |  |

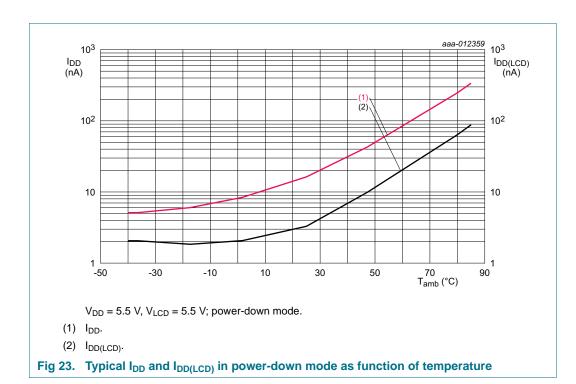
<sup>[1]</sup> For typical values, also see Figure 23 to Figure 25.

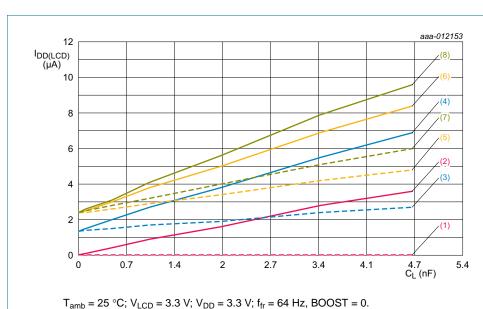
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<sup>[2]</sup>  $\,$  I2C pins SCL and SDA have no diode to  $\rm V_{DD}$  and may be driven up to 5.5 V.

<sup>[3]</sup> Outputs measured one at a time.

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(1) Static, all segments/elements off.

(2) Static, all segments/elements on.

(3) MUX 1:2, bias level ½, all segments/elements off.

(4) MUX 1:2, bias level ½, all segments/elements on.

(5) MUX 1:3, bias level 1/3, all segments/elements off.

(6) MUX 1:3, bias level  $\frac{1}{3}$ , all segments/elements on.

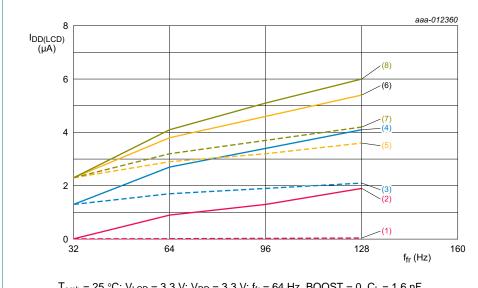
(7) MUX 1:4, bias level  $\frac{1}{3}$ , all segments/elements off.

(8) MUX 1:4, bias level  $\frac{1}{3}$ , all segments/elements on.

Fig 24. Typical  $I_{DD(LCD)}$  as function of display load

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 $T_{amb}$  = 25 °C;  $V_{LCD}$  = 3.3 V;  $V_{DD}$  = 3.3 V;  $f_{fr}$  = 64 Hz, BOOST = 0,  $C_L$  = 1.6 nF.

- (1) Static, all segments/elements off.
- (2) Static, all segments/elements on.
- (3) MUX 1:2, bias level ½, all segments/elements off.
- (4) MUX 1:2, bias level ½, all segments/elements on.
- (5) MUX 1:3, bias level \( \frac{1}{3} \), all segments/elements off.
- (6) MUX 1:3, bias level \( \frac{1}{3} \), all segments/elements on.
- (7) MUX 1:4, bias level  $\frac{1}{3}$ , all segments/elements off.
- (8) MUX 1:4, bias level  $\frac{1}{3}$ , all segments/elements on.

Fig 25. Typical I<sub>DD(LCD)</sub> as function of f<sub>fr</sub>

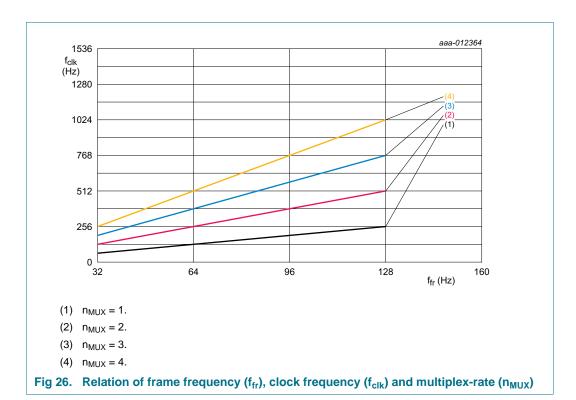
Table 19. Frequency characteristics

 $V_{DD}$  = 1.8 V to 5.5 V;  $V_{SS}$  = 0 V;  $V_{LCD}$  = 1.8 V to 5.5 V;  $T_{amb}$  = -40 °C to +85 °C; unless otherwise specified.

| Symbol                | Parameter                | Conditions                            |     | Min | Тур  | Max  | Unit |
|-----------------------|--------------------------|---------------------------------------|-----|-----|------|------|------|
| f <sub>fr</sub>       | frame frequency          | FF[1:0] = 00                          |     | -   | 32   | -    | Hz   |
|                       |                          | FF[1:0] = 01                          |     | 42  | 64   | 86   | Hz   |
|                       |                          | FF[1:0] = 10                          |     | -   | 96   | -    | Hz   |
|                       |                          | FF[1:0] = 11                          |     | -   | 128  | -    | Hz   |
| f <sub>clk(int)</sub> | internal clock frequency | $f_{fr} = 64 \text{ Hz}, n_{MUX} = 4$ | [1] | -   | 1024 | -    | Hz   |
| f <sub>clk(ext)</sub> | external clock frequency |                                       | [1] | -   | -    | 4096 | Hz   |
| t <sub>clk(H)</sub>   | HIGH-level clock time    | external clock                        |     | 60  | -    | -    | μS   |
| t <sub>clk(L)</sub>   | LOW-level clock time     | external clock                        |     | 60  | -    | -    | μS   |
| t <sub>w(rst)</sub>   | reset pulse width        | on pin RST                            |     | 10  | -    | -    | μS   |

[1]  $f_{clk(int)} = 2 \cdot f_{fr} \cdot n_{MUX}$  or  $f_{clk(ext)} = 2 \cdot f_{fr} \cdot n_{MUX}$  respectively (see <u>Table 6</u> and <u>Table 7</u>).

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Table 20. I<sup>2</sup>C-bus characteristics

 $V_{DD} = 1.8 \text{ V to } 5.5 \text{ V; } V_{SS} = 0 \text{ V; } T_{amb} = -40 \text{ °C to } +85 \text{ °C; } unless otherwise specified; all timing values are valid within the operating supply voltage and <math>T_{amb}$  range and are referenced to  $V_{IL}$  and  $V_{IH}$  with an input voltage swing of  $V_{SS}$  to  $V_{DD}$ .

| Symbol                | Parameter  | Conditions                  | Min      | Тур | Max | Unit |
|-----------------------|--|-----------------------------|----------|-----|-----|------|
| Pin SCL               |  |                             |          |     |     | '    |
| f <sub>SCL</sub>      | SCL clock frequency                              |                             | -        | -   | 400 | kHz  |
| t <sub>LOW</sub>      | LOW period of the SCL clock                      |                             | 1.3      | -   | -   | μS   |
| t <sub>HIGH</sub>     | HIGH period of the SCL clock                     |                             | 0.6      | -   | -   | μS   |
| Pin SDA               |  |                             | <u> </u> |     |     |      |
| t <sub>SU;DAT</sub>   | data set-up time                                 |                             | 100      | -   | -   | ns   |
| t <sub>HD;DAT</sub>   | data hold time                                   |                             | 0        | -   | -   | ns   |
| Pins SCL              | and SDA  |                             |          |     |     |      |
| t <sub>BUF</sub>      | bus free time between a STOP and START condition |                             | 1.3      | -   | -   | μS   |
| t <sub>SU;STO</sub>   | set-up time for STOP condition                   |                             | 0.6      | -   | -   | μS   |
| t <sub>HD;STA</sub>   | hold time (repeated)<br>START condition          |                             | 0.6      | -   | -   | μS   |
| t <sub>SU;STA</sub>   | set-up time for a repeated START condition       |                             | 0.6      | -   | -   | μS   |
| t <sub>r</sub>        | rise time of both SDA and SCL signals            | f <sub>SCL</sub> = 400 kHz  | -        | -   | 0.3 | μS   |
| t <sub>f</sub>        | fall time of both SDA and SCL signals            |                             | -        | -   | 0.3 | μS   |
| C <sub>b</sub>        | capacitive load for each bus line                |                             | -        | -   | 400 | pF   |
| t <sub>w(spike)</sub> | spike pulse width                                | on the I <sup>2</sup> C-bus | -        | -   | 50  | ns   |

<sup>[1]</sup> The  $I^2C$ -bus interface of PCF8551A is 5 V tolerant.

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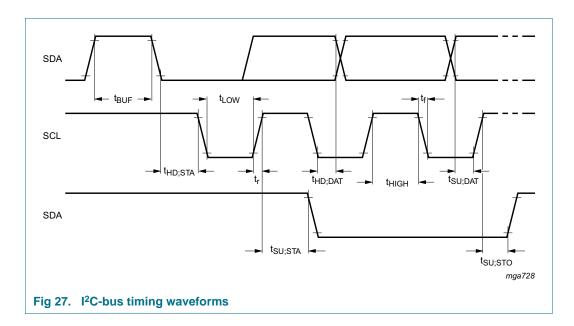
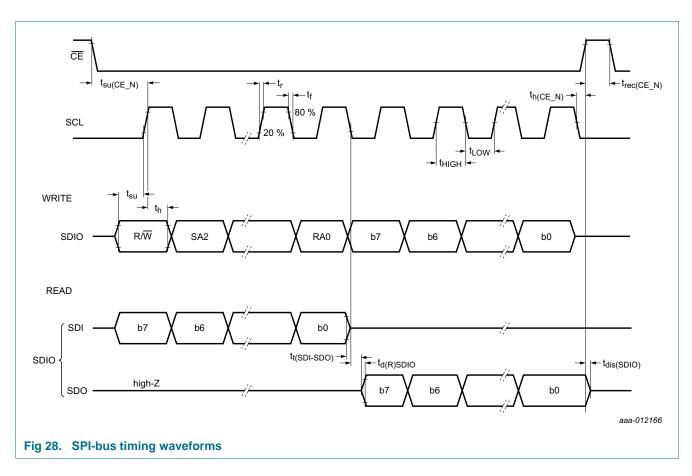


Table 21. SPI-bus characteristics

 $V_{DD} = 1.8 \text{ V}$  to 5.5 V;  $V_{SS} = 0 \text{ V}$ ;  $T_{amb} = -40 \text{ °C}$  to +85 °C; unless otherwise specified; all timing values are valid within the operating supply voltage and  $T_{amb}$  range and are referenced to  $V_{IL}$  and  $V_{IH}$  with an input voltage swing of  $V_{SS}$  to  $V_{DD}$ .

| Symbol                  | Parameter                       | Conditions             | Min | Тур | Max | Unit |
|-------------------------|---------------------------------|------------------------|-----|-----|-----|------|
| Pin SCL                 |                                 |                        |     |     |     | ,    |
| f <sub>SCL</sub>        | SCL clock frequency             |                        | -   | -   | 5   | MHz  |
| t <sub>LOW</sub>        | LOW period of the SCL clock     |                        | 150 | -   | -   | ns   |
| t <sub>HIGH</sub>       | HIGH period of the SCL clock    |                        | 80  | -   | -   | ns   |
| t <sub>r</sub>          | rise time                       |                        | -   | -   | 100 | ns   |
| t <sub>f</sub>          | fall time                       |                        | -   | -   | 100 | ns   |
| Pin CE                  |                                 |                        | ,   | '   |     |      |
| t <sub>su(CE_N)</sub>   | CE_N set-up time                |                        | 30  | -   | -   | ns   |
| t <sub>h(CE_N)</sub>    | CE_N hold time                  |                        | 10  | -   | -   | ns   |
| t <sub>rec(CE_N)</sub>  | CE_N recovery time              |                        | 70  | -   | -   | ns   |
| Pin SDIO                |                                 |                        |     | ·   | ·   | ·    |
| t <sub>su</sub>         | set-up time                     | write data             | 5   | -   | -   | ns   |
| t <sub>h</sub>          | hold time                       | write data             | 50  | -   | -   | ns   |
| t <sub>d(R)SDIO</sub>   | SDIO read delay time            | C <sub>L</sub> = 50 pF | -   | -   | 150 | ns   |
| t <sub>dis(SDIO)</sub>  | SDIO disable time               | no load                | -   | -   | 50  | ns   |
| t <sub>t(SDI-SDO)</sub> | transition time from SDI to SDO | write to read mode     | 0   | -   | -   | ns   |

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# 16. Application information

## 16.1 Power-on with a slowly starting power supply

The built-in POR block acts on the rising edge of the  $V_{DD}$  supply voltage. It is designed to react to fast slopes. If the system supply starts slowly, it is recommended to initiate a software reset immediately after power-on.

## 16.2 I<sup>2</sup>C acknowledge after power-on

If the bus does not show an acknowledge at the first access, the command should be sent a second time.

### 16.3 Resistors on I/O pins

The pin PORE comprises an internal, latching pull-down device, which keeps the input at a low potential when left open. If the input is supposed to be at logic 0 potential, this pin can be either connected to  $V_{SS}$  or left open.

In case the pin is supposed to be at logic 1 potential, it must be connected to  $V_{DD}$  to avoid any cross-current during power-up. A series resistance between  $V_{DD}$  and PORE must not exceed 1 k $\Omega$  to ensure proper functionality.

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## 17. Package outline

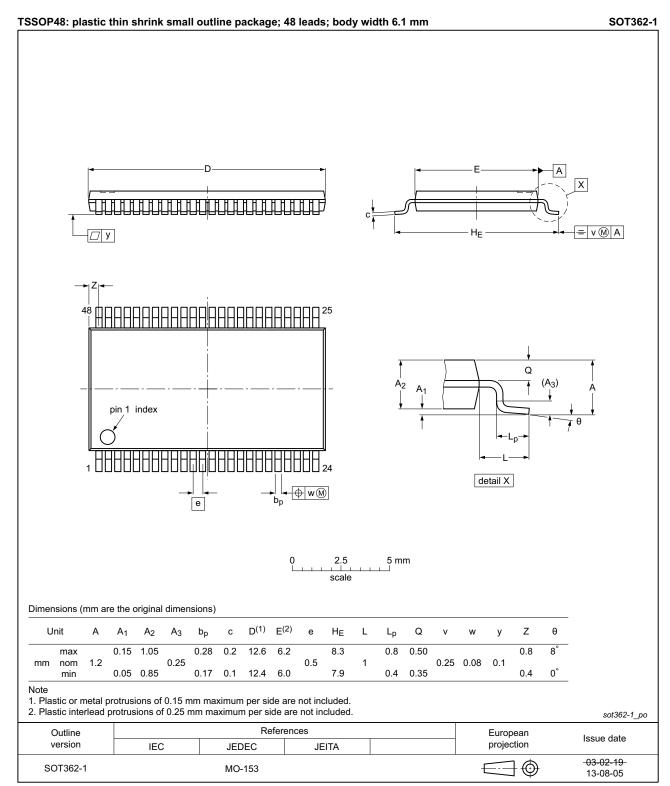


Fig 29. Package outline SOT362-1 (TSSOP48) of PCF8551

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## 18. Handling information

All input and output pins are protected against ElectroStatic Discharge (ESD) under normal handling. When handling Metal-Oxide Semiconductor (MOS) devices ensure that all normal precautions are taken as described in *JESD625-A*, *IEC 61340-5* or equivalent standards.

## 19. Packing information

### 19.1 Tape and reel information

For tape and reel packing information, see Ref. 11 "SOT362-1\_118" on page 48.

## 20. Soldering of SMD packages

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365* "Surface mount reflow soldering description".

### 20.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

### 20.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- Through-hole components
- Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- Board specifications, including the board finish, solder masks and vias
- Package footprints, including solder thieves and orientation
- The moisture sensitivity level of the packages

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- Package placement
- Inspection and repair
- Lead-free soldering versus SnPb soldering

## 20.3 Wave soldering

Key characteristics in wave soldering are:

- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- Solder bath specifications, including temperature and impurities

## 20.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see <u>Figure 30</u>) than a SnPb process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board
- Reflow temperature profile; this profile includes preheat, reflow (in which the board is heated to the peak temperature) and cooling down. It is imperative that the peak temperature is high enough for the solder to make reliable solder joints (a solder paste characteristic). In addition, the peak temperature must be low enough that the packages and/or boards are not damaged. The peak temperature of the package depends on package thickness and volume and is classified in accordance with Table 22 and 23

Table 22. SnPb eutectic process (from J-STD-020D)

| Package thickness (mm) | Package reflow temperature (°C) |       |  |  |  |
|------------------------|---------------------------------|-------|--|--|--|
|                        | Volume (mm³)                    |       |  |  |  |
|                        | < 350                           | ≥ 350 |  |  |  |
| < 2.5                  | 235                             | 220   |  |  |  |
| ≥ 2.5                  | 220                             | 220   |  |  |  |

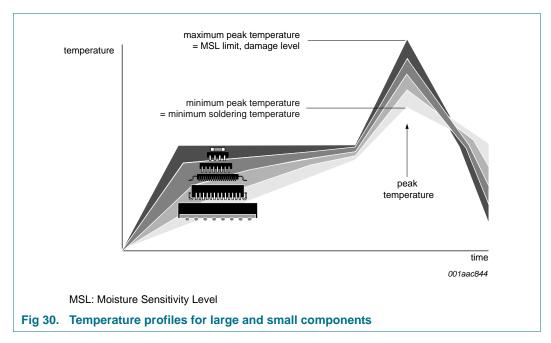
Table 23. Lead-free process (from J-STD-020D)

| Package thickness (mm) | Package reflow temperature (°C)  Volume (mm³) |             |        |  |  |  |  |  |
|------------------------|---|-------------|--------|--|--|--|--|--|
|                        |   |             |        |  |  |  |  |  |
|                        | < 350   | 350 to 2000 | > 2000 |  |  |  |  |  |
| < 1.6                  | 260   | 260         | 260    |  |  |  |  |  |
| 1.6 to 2.5             | 260   | 250         | 245    |  |  |  |  |  |
| > 2.5                  | 250   | 245         | 245    |  |  |  |  |  |

Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see <u>Figure 30</u>.

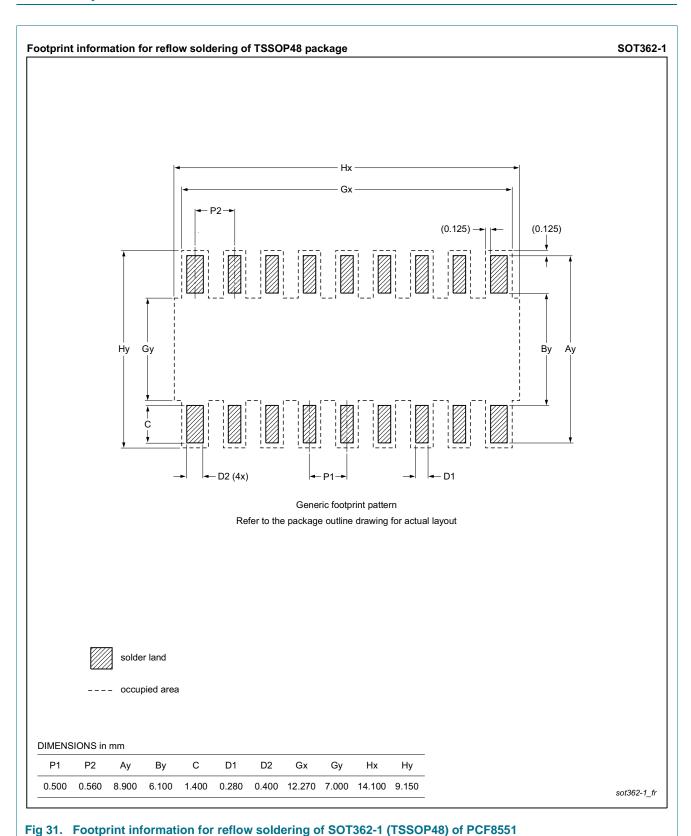
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For further information on temperature profiles, refer to Application Note *AN10365* "Surface mount reflow soldering description".

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# 21. Footprint information



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# 22.1 LCD segment driver selection

Table 24. Selection of LCD segment drivers

| Type name  | Num | Number of elements at MUX |     |     |     |     |     |            | V <sub>DD</sub> (V) V <sub>LCD</sub> (V) |                         | f <sub>fr</sub> (Hz) V <sub>LCD</sub> (V) |                        | T <sub>amb</sub> (°C) | Interface              | Package  | AEC- |
|------------|-----|---------------------------|-----|-----|-----|-----|-----|------------|--|-------------------------|---|------------------------|-----------------------|------------------------|----------|------|
|            | 1:1 | 1:2                       | 1:3 | 1:4 | 1:6 | 1:8 | 1:9 |            |  |                         | charge<br>pump                            | temperature compensat. |                       |                        |          | Q100 |
| PCA8553DTT | 40  | 80                        | 120 | 160 | -   | -   | -   | 1.8 to 5.5 | 1.8 to 5.5                               | 32 to 256[1]            | N   | N                      | -40 to 105            | I <sup>2</sup> C / SPI | TSSOP56  | Υ    |
| PCA8546ATT | -   | -                         | -   | 176 | -   | -   | -   | 1.8 to 5.5 | 2.5 to 9                                 | 60 to 300[1]            | N   | N                      | -40 to 95             | I <sup>2</sup> C       | TSSOP56  | Υ    |
| PCA8546BTT | -   | -                         | -   | 176 | -   | -   | -   | 1.8 to 5.5 | 2.5 to 9                                 | 60 to 300[1]            | N   | N                      | -40 to 95             | SPI                    | TSSOP56  | Υ    |
| PCA8547AHT | 44  | 88                        | -   | 176 | -   | -   | -   | 1.8 to 5.5 | 2.5 to 9                                 | 60 to 300 <sup>11</sup> | Υ   | Υ                      | -40 to 95             | I <sup>2</sup> C       | TQFP64   | Υ    |
| PCA8547BHT | 44  | 88                        | -   | 176 | -   | -   | -   | 1.8 to 5.5 | 2.5 to 9                                 | 60 to 300 <sup>11</sup> | Υ   | Υ                      | -40 to 95             | SPI                    | TQFP64   | Υ    |
| PCF85134HL | 60  | 120                       | 180 | 240 | -   | -   | -   | 1.8 to 5.5 | 2.5 to 6.5                               | 82                      | N   | N                      | -40 to 85             | I <sup>2</sup> C       | LQFP80   | N    |
| PCA85134H  | 60  | 120                       | 180 | 240 | -   | -   | -   | 1.8 to 5.5 | 2.5 to 8                                 | 82                      | N   | N                      | -40 to 95             | I <sup>2</sup> C       | LQFP80   | Υ    |
| PCA8543AHL | 60  | 120                       | -   | 240 | -   | -   | -   | 2.5 to 5.5 | 2.5 to 9                                 | 60 to 300[1]            | Υ   | Υ                      | -40 to 105            | I <sup>2</sup> C       | LQFP80   | Υ    |
| PCF8545ATT | -   | -                         | -   | 176 | 252 | 320 | -   | 1.8 to 5.5 | 2.5 to 5.5                               | 60 to 300[1]            | N   | N                      | -40 to 85             | I <sup>2</sup> C       | TSSOP56  | N    |
| PCF8545BTT | -   | -                         | -   | 176 | 252 | 320 | -   | 1.8 to 5.5 | 2.5 to 5.5                               | 60 to 300[1]            | N   | N                      | -40 to 85             | SPI                    | TSSOP56  | N    |
| PCF8536AT  | -   | -                         | -   | 176 | 252 | 320 | -   | 1.8 to 5.5 | 2.5 to 9                                 | 60 to 300[1]            | N   | N                      | -40 to 85             | I <sup>2</sup> C       | TSSOP56  | N    |
| PCF8536BT  | -   | -                         | -   | 176 | 252 | 320 | -   | 1.8 to 5.5 | 2.5 to 9                                 | 60 to 300[1]            | N   | N                      | -40 to 85             | SPI                    | TSSOP56  | N    |
| PCA8536AT  | -   | -                         | -   | 176 | 252 | 320 | -   | 1.8 to 5.5 | 2.5 to 9                                 | 60 to 300[1]            | N   | N                      | -40 to 95             | I <sup>2</sup> C       | TSSOP56  | Υ    |
| PCA8536BT  | -   | -                         | -   | 176 | 252 | 320 | -   | 1.8 to 5.5 | 2.5 to 9                                 | 60 to 300[1]            | N   | N                      | -40 to 95             | SPI                    | TSSOP56  | Υ    |
| PCF8537AH  | 44  | 88                        | -   | 176 | 276 | 352 | -   | 1.8 to 5.5 | 2.5 to 9                                 | 60 to 300[1]            | Υ   | Υ                      | -40 to 85             | I <sup>2</sup> C       | TQFP64   | N    |
| PCF8537BH  | 44  | 88                        | -   | 176 | 276 | 352 | -   | 1.8 to 5.5 | 2.5 to 9                                 | 60 to 300[1]            | Υ   | Υ                      | -40 to 85             | SPI                    | TQFP64   | N    |
| PCA8537AH  | 44  | 88                        | -   | 176 | 276 | 352 | -   | 1.8 to 5.5 | 2.5 to 9                                 | 60 to 300[1]            | Υ   | Υ                      | -40 to 95             | I <sup>2</sup> C       | TQFP64   | Υ    |
| PCA8537BH  | 44  | 88                        | -   | 176 | 276 | 352 | -   | 1.8 to 5.5 | 2.5 to 9                                 | 60 to 300[1]            | Υ   | Υ                      | -40 to 95             | SPI                    | TQFP64   | Υ    |
| PCA9620H   | 60  | 120                       | -   | 240 | 320 | 480 | -   | 2.5 to 5.5 | 2.5 to 9                                 | 60 to 300[1]            | Υ   | Υ                      | -40 to 105            | I <sup>2</sup> C       | LQFP80   | Υ    |
| PCA9620U   | 60  | 120                       | -   | 240 | 320 | 480 | -   | 2.5 to 5.5 | 2.5 to 9                                 | 60 to 300[1]            | Υ   | Υ                      | -40 to 105            | I <sup>2</sup> C       | Bare die | Υ    |
| PCF8576DU  | 40  | 80                        | 120 | 160 | -   | -   | -   | 1.8 to 5.5 | 2.5 to 6.5                               | 77                      | N   | N                      | -40 to 85             | I <sup>2</sup> C       | Bare die | N    |
| PCF8576EUG | 40  | 80                        | 120 | 160 | -   | -   | -   | 1.8 to 5.5 | 2.5 to 6.5                               | 77                      | N   | N                      | -40 to 85             | I <sup>2</sup> C       | Bare die | N    |
| PCA8576FUG | 40  | 80                        | 120 | 160 | -   | -   | -   | 1.8 to 5.5 | 2.5 to 8                                 | 200                     | N   | N                      | -40 to 105            | I <sup>2</sup> C       | Bare die | Υ    |
| PCF85133U  | 80  | 160                       | 240 | 320 | -   | -   | -   | 1.8 to 5.5 | 2.5 to 6.5                               | 82, 110 <sup>[2]</sup>  | N   | N                      | -40 to 85             | I <sup>2</sup> C       | Bare die | N    |
| PCA85133U  | 80  | 160                       | 240 | 320 | -   | -   | -   | 1.8 to 5.5 | 2.5 to 8                                 | 82, 110 <sup>[2]</sup>  | N   | N                      | -40 to 95             | I <sup>2</sup> C       | Bare die | Υ    |

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Table 24. Selection of LCD segment drivers ...continued

| Type name  | Num | Number of elements at MUX |     |     |     |     |     | V <sub>DD</sub> (V) | V <sub>LCD</sub> (V) | f <sub>fr</sub> (Hz)    | V <sub>LCD</sub> (V) | V <sub>LCD</sub> (V)   | T <sub>amb</sub> (°C) | Interface              | Package  | AEC- |
|------------|-----|---------------------------|-----|-----|-----|-----|-----|---------------------|----------------------|-------------------------|----------------------|------------------------|-----------------------|------------------------|----------|------|
|            | 1:1 | 1:2                       | 1:3 | 1:4 | 1:6 | 1:8 | 1:9 |                     |                      |                         | charge<br>pump       | temperature compensat. |                       |                        |          | Q100 |
| PCA85233UG | 80  | 160                       | 240 | 320 | -   | -   | -   | 1.8 to 5.5          | 2.5 to 8             | 150, 220 <sup>[2]</sup> | N                    | N                      | -40 to 105            | I <sup>2</sup> C       | Bare die | Υ    |
| PCF85132U  | 160 | 320                       | 480 | 640 | -   | -   | -   | 1.8 to 5.5          | 1.8 to 8             | 60 to 90[1]             | N                    | N                      | -40 to 85             | I <sup>2</sup> C       | Bare die | N    |
| PCA8530DUG | 102 | 204                       | -   | 408 | -   | -   | -   | 2.5 to 5.5          | 4 to 12              | 45 to 300[1]            | Υ                    | Υ                      | -40 to 105            | I <sup>2</sup> C / SPI | Bare die | Υ    |
| PCA85132U  | 160 | 320                       | 480 | 640 | -   | -   | -   | 1.8 to 5.5          | 1.8 to 8             | 60 to 90[1]             | N                    | N                      | -40 to 95             | I <sup>2</sup> C       | Bare die | Y    |
| PCA85232U  | 160 | 320                       | 480 | 640 | -   | -   | -   | 1.8 to 5.5          | 1.8 to 8             | 117 to 176[1]           | N                    | N                      | -40 to 95             | I <sup>2</sup> C       | Bare die | Υ    |
| PCF8538UG  | 102 | 204                       | -   | 408 | 612 | 816 | 918 | 2.5 to 5.5          | 4 to 12              | 45 to 300[1]            | Υ                    | Υ                      | -40 to 85             | I <sup>2</sup> C / SPI | Bare die | N    |
| PCA8538UG  | 102 | 204                       | -   | 408 | 612 | 816 | 918 | 2.5 to 5.5          | 4 to 12              | 45 to 300[1]            | Υ                    | Υ                      | -40 to 105            | I <sup>2</sup> C / SPI | Bare die | Υ    |

<sup>[1]</sup> Software programmable.

<sup>[2]</sup> Hardware selectable.

## Universal 36 × 4 LCD segment driver

## 23. Abbreviations

Table 25. Abbreviations

| Acronym          | Description                   |
|------------------|-------------------------------|
| CDM              | Charged-Device Model          |
| DC               | Direct Current                |
| EMC              | ElectroMagnetic Compatibility |
| ESD              | ElectroStatic Discharge       |
| HBM              | Human Body Model              |
| I <sup>2</sup> C | Inter-Integrated Circuit bus  |
| IC               | Integrated Circuit            |
| LCD              | Liquid Crystal Display        |
| LSB              | Least Significant Bit         |
| MSB              | Most Significant Bit          |
| MSL              | Moisture Sensitivity Level    |
| MUX              | Multiplexer                   |
| PCB              | Printed-Circuit Board         |
| POR              | Power-On Reset                |
| RC               | Resistance-Capacitance        |
| RMS              | Root Mean Square              |
| SCL              | Serial CLock line             |
| SDA              | Serial DAta line              |
| SMD              | Surface-Mount Device          |
| SPI              | Serial Peripheral Interface   |

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- [11] SOT362-1\_118 TSSOP48; Reel pack; SMD, 13", packing information
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- [13] UM10569 Store and transport requirements

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# 25. Revision history

#### Table 26. Revision history

| Document ID    | Release date | Data sheet status  | Change notice | Supersedes  |
|----------------|--------------|--|---------------|-------------|
| PCF8551 v.2    | 20150216     | Product data sheet   | -             | PCF8551 v.1 |
| Modifications: |              | and I <sub>DD(LCD)</sub> values in <u>Table 18</u> roduct data sheet |               |             |
| PCF8551 v.1    | 20141205     | Objective data sheet   | -             | -           |

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|--------------------------------|-------------------|---|
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